

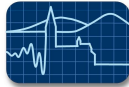
TPC Readout with TimePix + 3GEMs

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EUDET Annual Meeting, Amsterdam, 6. Oct. 2008

GEFÖRDERT VOM



Bundesministerium
für Bildung
und Forschung

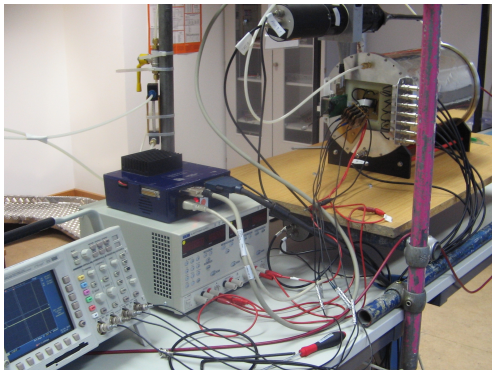


Goal

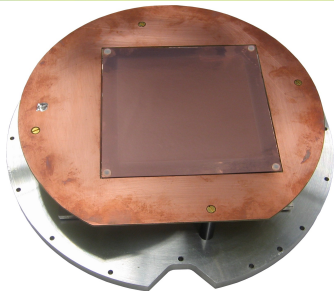
- A readout module with 8 TimePix chips and 3 GEM gas amplification for the EUDET Large Prototype TPC

Steps

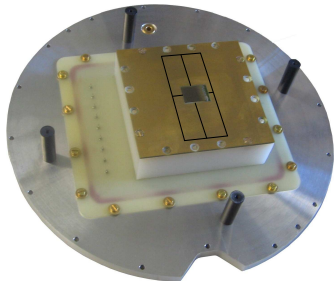
- Operate small prototype with TimePix + 3GEM
- Set up software reconstruction chain
- Build LP Module



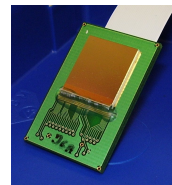
- Field cage designed and produced in Aachen
 - 26 cm diameter
 - 26 cm drift distance
 - Low material budget: 1 % X_0
 - Drift field up to 1 kV/cm
 - Fits into 5 T magnet at DESY
- Trigger for cosmic muons: Scintillators above and below the chamber
 - Veto circuit: Only one shutter window per recorded frame
- TimePix readout with Muros and PixelMan



- Triple-GEM stack
- 1 mm transfer gaps and induction gap
- 390 V across each GEM
- Transfer field 2500 V/cm
- Induction field 3000 V/cm



- TimePix
 - 256×256 Pixel²
 - $55 \times 55 \mu\text{m}^2$ pixel size
 - Active area $14 \times 14 \text{ mm}^2$
- Single chip board
Modified Freiburg design to glue board into readout plane from the back
- 4 large pads, connected to preamps and oscilloscope



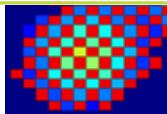
Measurements



- 40,000 cosmic tracks
- 40,000 test beam tracks

TimePix operated in "Mixed Mode":
Chequerboard pattern with pixels alternating in

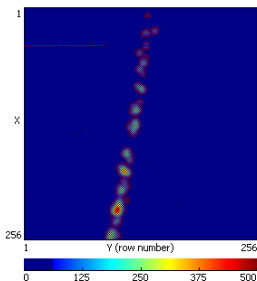
- Time Mode
- Time-Over-Threshold Mode proportional to charge



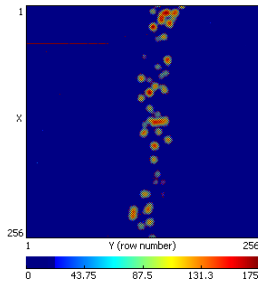
Cluster recorded in mixed mode

- Red: Time
- Blue to green: Charge

- Gas: Ar/CO₂ 70/30
- Drift field: 500 V/cm
- GEM voltages: 390 V
- Transfer fields: 2500 V/cm
- Induction field: 3000 V/cm



short drift distance

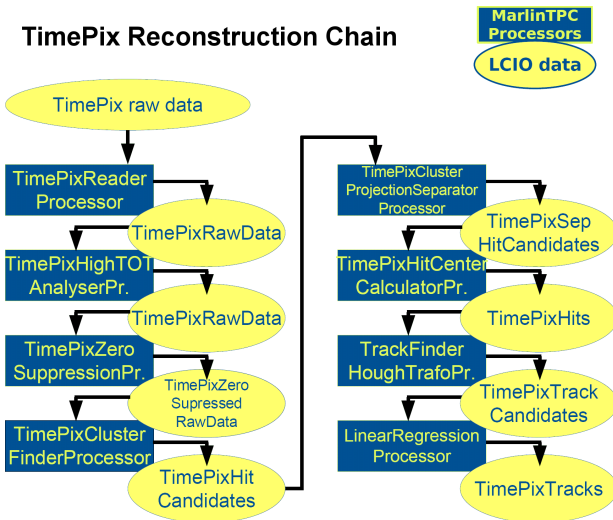


long drift distance

PixelMan
Event
Display

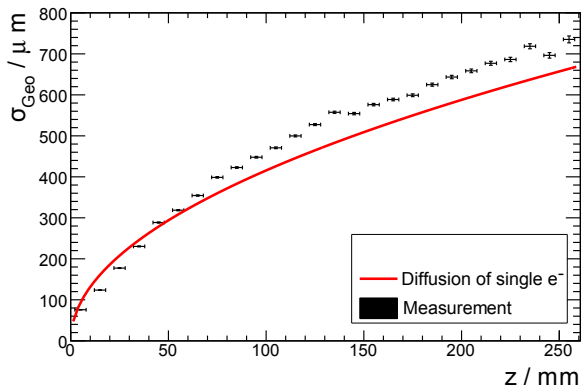
MarlinTPC is the TPC simulation, digitisation, reconstruction and analysis package for the Marlin framework

TimePix Reconstruction Chain



Very modular with more than 50 processors, suited for all kinds of TPC readout (GEMs/Micromegas, ADCs, TDCs, TimePix)

- Reader for TimePix data from PixelMan
- Complete TimePix reconstruction chain
- Analysis processors (e. g. to determine spatial resolution)
- TimePix digitisation



Current interpretation:

- Short drift distances: Multi-electron clusters
- Long drift distances: Single-electron clusters?

Single electrons

$$\sigma = \sqrt{D_t^2 z}$$

$$D_t = \text{Transverse diffusion in } \mu\text{m}/\sqrt{\text{cm}}$$

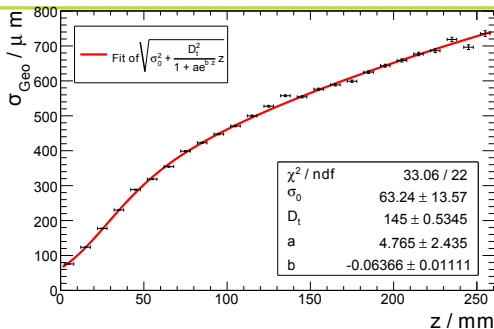
More realistic assumption

$$\sigma = \sqrt{\sigma_0^2 + \frac{D_t^2}{n_{\text{ele}}} z}$$

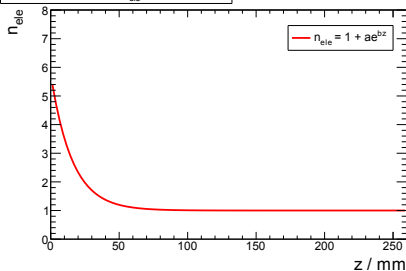
$$\sigma_0 = \text{Intrinsic detector resolution}$$

$$n_{\text{ele}} = 1 + a e^{-bz}$$

= Number of primary electrons
contributing to recorded cluster



z dependence of n_{ele} from rms fit



- $n_{\text{ele,max}} = 5.7$

- $\bar{n}_{\text{primary}} \approx 3$

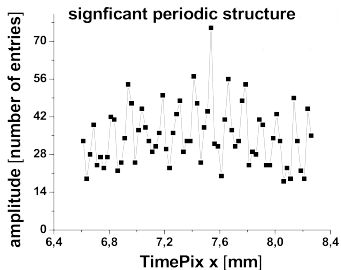
\Rightarrow 1.9 primary ionisation clusters
in one recorded cluster

Not understood yet:

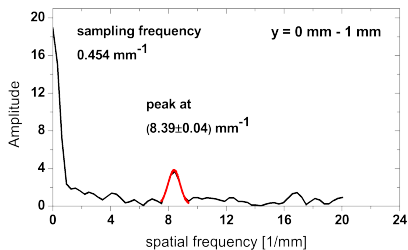
- Number of recorded clusters is too low

- Diffusion is not consistent with Magboltz'
($131.4 \mu\text{m}/\sqrt{\text{cm}}$)

GEM structure shows up in reconstructed data



Fourier analysis



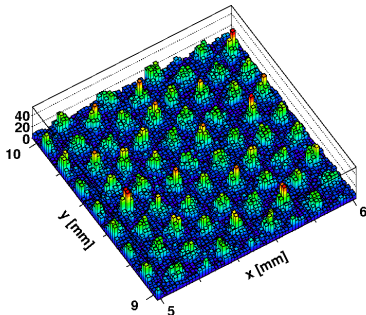
- Fourier transform: Period is $119 \pm 6 \mu\text{m}$ (GEM pitch in x-projection is $120 \mu\text{m}$)
- Signal only shows up in first millimetre
- For larger drift distances signal is smeared out due to diffusion
- Drift gap 6 mm
- Transfer gaps 2 mm each
- Induction gap 1 mm



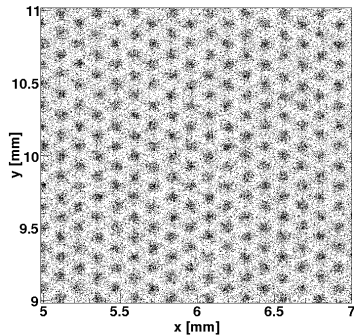
- Dedicated high statistics run with ^{90}Sr source untriggered, no z information available
- Long drift distance ≈ 25 cm
- GEM spacing: 1 mm transfer gaps and induction gap

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Distribution of Cluster Centres



Distribution of Cluster Centres



We can see every single GEM hole!

Current interpretation:

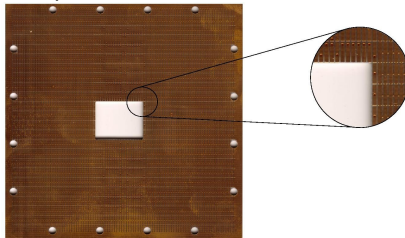
Spatial separation of the electrons originating from multiple-electron clusters occurs due to the transverse diffusion.

- Very small drift distances:
All electrons of a primary cluster pass through the same GEM hole, GEM structure shows up
- Medium drift distances:
Electrons of a primary cluster pass through neighbouring GEM holes, GEM structure is washed out
- Long drift distances:
Individual electrons can be separated, GEM structure shows up

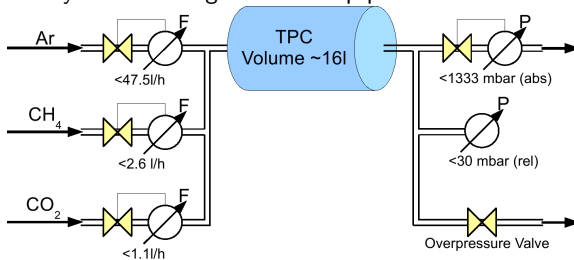
Problems with this interpretation:

- Number of reconstructed clusters at large drift distances is smaller than expected number of primary electrons (about 1/3)
 - Attachment?
 - Low single electron efficiency?
 - Do reconstructed clusters contain only single electrons?

- Combined readout:
Pad plane with 256 pads, $1 \times 4 \text{ mm}^2$ + TimePix



- Gas system to mix gases and keep pressure constant



Freiburg group is testing MediPix chips with enlarged pixels ($110 \times 110 \mu\text{m}^2$), post-processed on per chip level by FMF (Freiburger Metallforschungszentrum)



Bonn has established first contact with IZM:
Institut für Zuverlässigkeit und Mikrointegration, Berlin

Institut
Zuverlässigkeit und
Mikrointegration

Post-Processing of TimePix chips — on wafer level:

- **Enlarging pixel size**
by adding metal pads on a passivation
- **Silicon through vias:**
replacing wire bonds by bump bonds
- **InGrid** — plans to learn technology from Twente University

Contributions to the development of a TimePix successor chip.

- 3 standard GEMs $10 \times 10 \text{ cm}^2$
- 1 mm transfer gaps and induction gap
- Two quad-boards (NIKHEF) with 4 TimePix chips each



anode plane

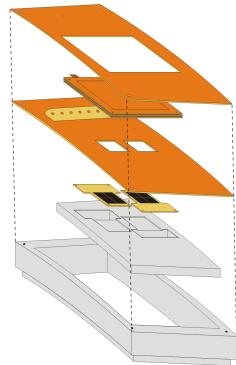
GEMs

readout plane

quad-boards

reinforcement of
anode plane

redframe



- Two Prague USB 1.22 readout modules, read out by Pixelman

Module

- All components are in house
- GEMs have to be glued

QuadBoards

- One QuadBoard is fully equipped and bonded
- QuadBoard worked fine except for a broken bond (could not read DAC values from second chip)
- After fixing the bond the board does not answer any more
- Probed the individual chips: All chips are dead!

Problem not understood!

- New QuadBoard is being prepared

Status

- First module is produced and being surveyed
- Six further modules are in production
- All dummy modules will be ready for closing of the LP in week 44

Prototype in Bonn

- 26 cm TPC with single TimePix + 3GEM
- 40.000 cosmics tracks + 40.000 test beam tracks
- Resolution limited by GEMs + diffusion
- Indications that we see single electron clusters

MarlinTPC

- TimePix reconstruction chain is ready to use
- For LP: Need multi-chip capability

LP Modules

- Dummy modules in production, will be ready for LP
- TimePix + 3GEM module: QuadBoards are being tested